



## Customer Information Notification

202211040I : IMX 8M Mini Datasheet Updated to Rev .2

**Note:** This notice is NXP Company Proprietary.

**Issue Date:** Dec 14, 2022 **Effective date:** Dec 15, 2022

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### Management summary

Industrial and Consumer Datasheet (DS) update for i.MX 8M Mini to revision 2

### Change Category

- |  |   |  |   |  |
|--|---|--|---|--|
| <input type="checkbox"/> Wafer Fab Process   | <input type="checkbox"/> Assembly Process   | <input type="checkbox"/> Product Marking           | <input type="checkbox"/> Test Process   | <input type="checkbox"/> Design                                    |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification  | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Errata                                    |
| <input type="checkbox"/> Wafer Fab Location  | <input type="checkbox"/> Assembly Location  | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Location  | <input checked="" type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware            | <input type="checkbox"/> Other              |  |   |  |

## PCN Overview

### Description

NXP Semiconductors announces Industrial and Consumer Datasheet (DS) update for i.MX 8M MINI to revision 2. The revision history included in the updated document provides a detailed description of the changes.

Industrial and Consumer Datasheet Changes Summary:  
Please refer to the revision history.

The i.MX 8M Mini Industrial and Consumer Datasheet Rev.2 are attached to this notice, and can be found at:

<https://www.nxp.com/docs/en/data-sheet/IMX8MMIEC.pdf>

<https://www.nxp.com/docs/en/data-sheet/IMX8MMCEC.pdf>

### Reason

The datasheet has been updated to correct errors, provide additional technical clarification on some device features.

### Identification of Affected Products

Product identification does not change

### Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

### **Data Sheet Revision**

A new datasheet will be issued

### **Additional information**

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Additional documents: [view online](#)

### **Contact and Support**

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For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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